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Kind regards,

Team Nexperia



# **BAT54W series**

# Schottky barrier diodes Rev. 3 — 20 November 2012

**Product data sheet** 

### **Product profile**

### 1.1 General description

Planar Schottky barrier diodes with an integrated guard ring for stress protection, encapsulated in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

#### 1.2 Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

### 1.3 Applications

- Ultra high-speed switching
- Line termination

- Voltage clamping
- Reverse polarity protection

#### 1.4 Quick reference data

**Quick reference data**  $T_{amb} = 25 \, ^{\circ}\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
$V_R$	reverse voltage		-	-	30	V
V <sub>F</sub>	forward voltage	$I_F = 100 \text{ mA}$	<u>[1]</u> _	-	800	mV
$I_R$	reverse current	$V_{R} = 25 \text{ V}$	<u>[1]</u> _	-	2	μΑ

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

#### 2. **Pinning information**

Table 2. **Pinning** Pin Description Simplified outline **Graphic symbol** BAT54W anode not connected 2 3 cathode



 Table 2.
 Pinning ...continued

Pin	Description	Simplified outline	Graphic symbol
BAT54AW			
1	cathode (diode 1)		•
2	cathode (diode 2)	3	3
3	common anode	1 2	1 2 006aaa439
BAT54CW			
1	anode (diode 1)		
2	anode (diode 2)	3	3
3	common cathode	1 2	1 2 2
BAT54SW			
1	anode (diode 1)		_
2	cathode (diode 2)	3	3
3	cathode (diode 1), anode (diode 2)	1 2	1 006aaa437

# 3. Ordering information

Table 3. Ordering information

Type number	Package	Package			
	Name	Description	Version		
BAT54W series	SC-70	plastic surface-mounted package; 3 leads	SOT323		

# 4. Marking

Table 4. Marking codes

Type number	Marking code <sup>[1]</sup>
BAT54W	L4*
BAT54AW	42*
BAT54CW	43*
BAT54SW	44*

[1] \* = placeholder for manufacturing site code.

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		• • •	,		
Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
$V_R$	reverse voltage		-	30	V
I <sub>F</sub>	forward current		-	200	mA
I <sub>FRM</sub>	repetitive peak forward current	$t_p \leq \text{1 s; } \delta \leq 0.5$		300	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; t <sub>p</sub> < 10 ms	<u>[1]</u> -	600	mA
Per device	; one diode loaded				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[2] _	200	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup>  $T_i = 25$  °C before surge.

### 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device;	one diode loaded					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1] _	-	625	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

### 7. Characteristics

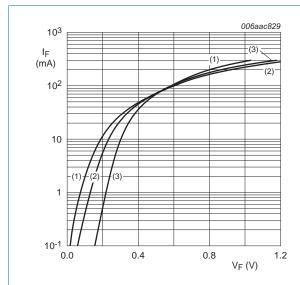
Table 7. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	9					
V <sub>F</sub>	forward voltage		<u>[1]</u>			
		$I_F = 0.1 \text{ mA}$	-	-	240	mV
		I <sub>F</sub> = 1 mA	-	-	320	mV
		I <sub>F</sub> = 10 mA	-	-	400	mV
		I <sub>F</sub> = 30 mA	-	-	500	mV
		I <sub>F</sub> = 100 mA	-	-	800	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 25 V	<u>[1]</u> _	-	2	μΑ
$C_{d}$	diode capacitance	$f = 1 MHz; V_R = 1 V$	-	-	10	pF
t <sub>rr</sub>	reverse recovery time		[2] _	-	5	ns

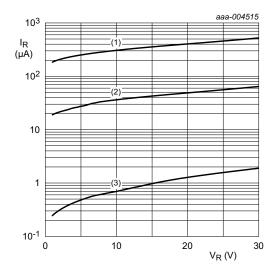
<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

<sup>[2]</sup> When switched from  $I_F$  = 10 mA to  $I_R$  = 10 mA;  $R_L$  = 100  $\Omega$ ; measured at  $I_R$  = 1 mA.



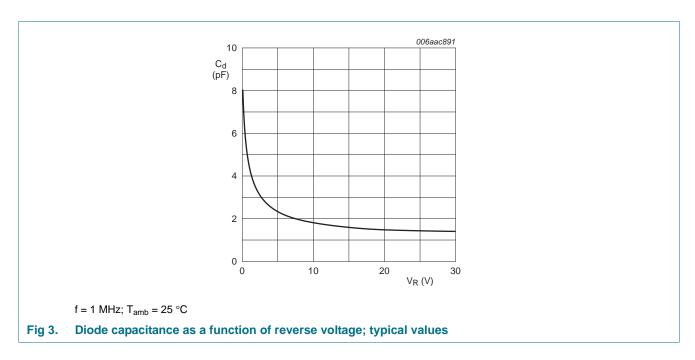
- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3) T<sub>amb</sub> = 25 °C

Fig 1. Forward current as a function of forward voltage; typical values

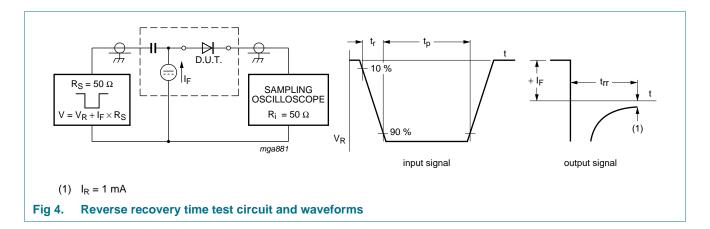


- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values



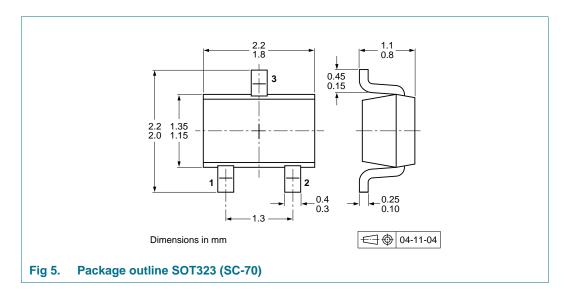
### 8. Test information



### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

# 9. Package outline



# 10. Packing information

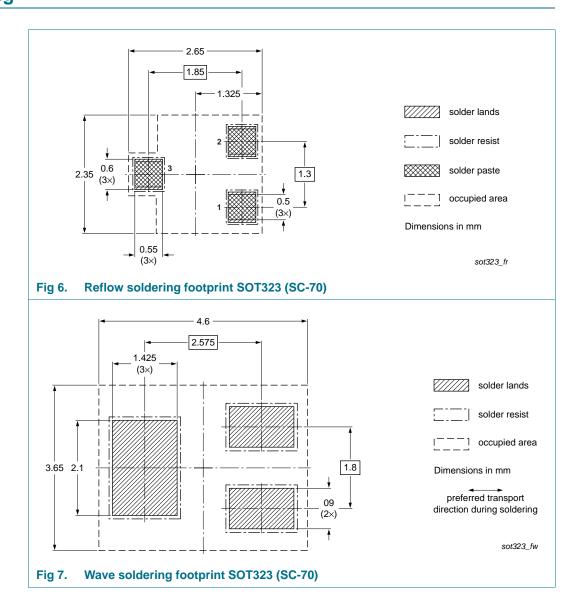
Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			3000	10000
BAT54W series	SOT323	4 mm pitch, 8 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see Section 14.

# 11. Soldering



# 12. Revision history

### Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
BAT54W_SER v.3	20121120	Product data sheet	-	BAT54W v.2		
Modifications:		of this document has been of NXP Semiconductors.	redesigned to comply w	rith the new identity		
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
	Section 1: updated					
	<ul> <li>Section 4: updated</li> </ul>					
	<ul> <li><u>Table 5</u>: updated ambient temperature T<sub>amb</sub> maximum value to 150 °C</li> </ul>					
	• Figure 1 to 4: updated					
	Section 8 "Test information": added					
	<ul> <li>Figure 5: replaced by minimized package outline drawing</li> </ul>					
	Section 10 "Packing information": added					
	<ul> <li>Section 11 "Soldering": added</li> </ul>					
	<ul> <li>Section 13 <sup>c</sup></li> </ul>	<u>'Legal information"</u> : update	d			
BAT54W v.2	19960319	Product specification	-	BAT54W v.1		

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BAT54W\_SER

# **BAT54W** series

#### Schottky barrier diodes

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### 15. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 5
8.1	Quality information 5
9	Package outline 6
10	Packing information 6
11	Soldering 7
12	Revision history 8
13	Legal information 9
13.1	Data sheet status 9
13.2	Definitions9
13.3	Disclaimers
13.4	Trademarks10
14	Contact information 10
15	Contents 11

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